

Chip Beads

For power line

ACC series

Туре:	HFxxACC2012	[0805 inch]*
	HFxxACC3216	[1206 inch]
	HFxxACC3225	[1210 inch]
	HFxxACC4532	[1812 inch]
		* Dimensions Code [EIA]

Issue date: September 2012

• All specifications are subject to change without notice.

• Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

公TDK

Chip Beads For Power Line

ACC Series

HFxxACC2012, HFxxACC3216, HFxxACC3225, HFxxACC4532

FEATURES

- With 4 types rated at 1.5A and 3 types rated at 3A, and with a range of frequency characteristics available for each type, the ACC series facilitates selection of the most appropriate part for any given application.
- Effective EMC suppression over a broad band can be achieved simply be inserting this product into the DC power line on the circuit board.
- · Available reflow soldering.
- It is a product conforming to RoHS directive.

PRODUCT IDENTIFICATION

 $\frac{\text{HF70}}{(1)} \frac{\text{ACC}}{(2)} \frac{201209}{(3)} - \frac{\text{T}}{(4)}$

- (1) Material name
- (2) Series name
- (3) Dimension code
- (4) Packaging style
 - T: ø180mm reel taping
 - TL: ø330mm reel taping

SPECIFICATIONS

Operating temperature range	–40 to +125°C
Storage temperature range	–40 to +125°C(After mount)

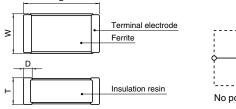
PACKAGING STYLE AND QUANTITIES

Packaging style	Туре	Quantity
	201209	2000 pieces/reel
Toping	321611	2000 pieces/reel
Taping	322513 2000 pieces/reel	
	453215	1000 pieces/reel

HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- · Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

SHAPES AND DIMENSIONS/CIRCUIT DIAGRAM



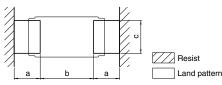


Dimensions in mm

Туре	L	W	Т	D
201209	2.0±0.2	1.25±0.2	0.9±0.2	0.3±0.2
321611	3.2±0.2	1.6±0.2	1.1±0.2	0.3±0.2
322513	3.2±0.2	2.5±0.2	1.3±0.2	0.3±0.2
453215	4.5±0.25	3.2±0.25	1.5±0.25	0.3±0.2

• Dimension without tolerance is reference value.

RECOMMENDED PC BOARD PATTERN REFLOW SOLDERING



Dimensions in mm

Туре	а	b	С	
201209	1.0	1.0	1.0	
321611	1.1	2.2	1.4	
322513	1.1	2.2	2.3	
453215	1.5	3.0	3.0	

• Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

• Please contact our Sales office when your application is considered the following: The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

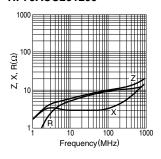
• All specifications are subject to change without notice.

公TDK

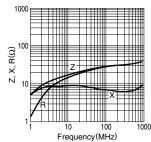
ELECTRICAL CHARACTERISTICS

Shape	Part No.	Impedance (Ω)[100MHz]	DC resistance (Ω)max.	Rated current (A)max.
	HF70ACC201209	10±25%	0.03	1.5
201209	HF50ACC201209	11±25%	0.03	1.5
	HF30ACC201209	7±25%	0.03	1.5
	HF70ACC321611	26±25%	0.04	1.5
321611	HF50ACC321611	31±25%	0.04	1.5
	HF30ACC321611	19±25%	0.04	1.5
	HF70ACC322513	52±25%	0.05	1.5
322513	HF50ACC322513	60±25%	0.05	1.5
	HF30ACC322513	31±25%	0.05	1.5
	HF70ACC453215	120±25%	0.05	1.5
453215	HF50ACC453215	125±25%	0.05	1.5
	HF30ACC453215	70±25%	0.05	1.5

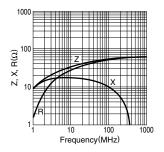
TYPICAL ELECTRICAL CHARACTERISTICS Z, X, R vs. FREQUENCY CHARACTERISTICS HF70ACC201209 HF



HF70ACC321611

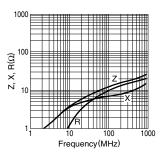


HF70ACC322513

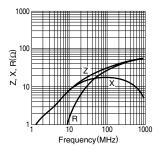


• TEST EQUIPMENT: RF IMPEDANCE ANALYZER YHP4191A

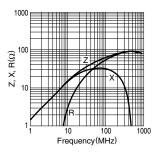
HF50ACC201209



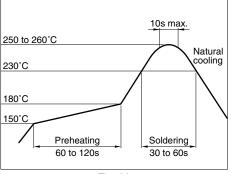
HF50ACC321611



HF50ACC322513

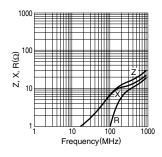


RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING

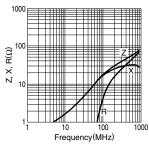


Time(s)

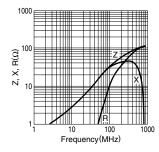
HF30ACC201209



HF30ACC321611



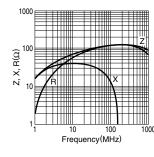
HF30ACC322513

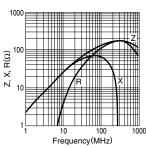


• All specifications are subject to change without notice.

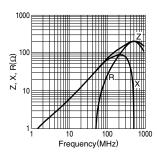


TYPICAL ELECTRICAL CHARACTERISTICS Z, X, R vs. FREQUENCY CHARACTERISTICS HF70ACC453215 HF50ACC453215



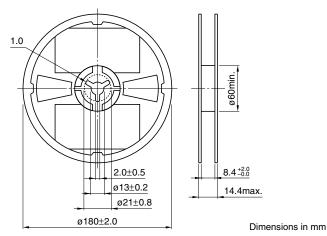


HF30ACC453215

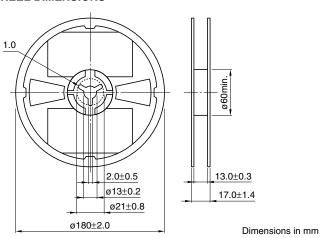


• TEST EQUIPMENT: RF IMPEDANCE ANALYZER YHP4191A

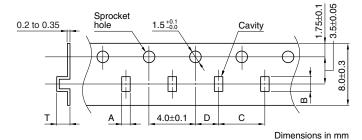
PACKAGING STYLES 201209 TO 322513 TYPES REEL DIMENSIONS



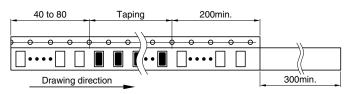
453215 TYPE REEL DIMENSIONS



TAPE DIMENSIONS

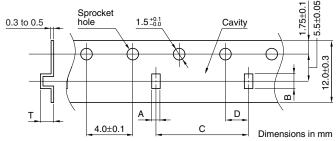


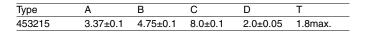
Туре	А	В	С	D	Т
201209	1.4±0.1	2.25±0.1	4.0±0.1	2.0±0.05	1.25max.
321611	1.75±0.1	3.45±0.1	4.0±0.1	2.0±0.05	1.4max.
322513	2.6±0.1	3.45±0.1	4.0±0.1	2.0±0.05	1.6max.

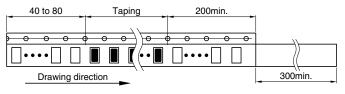


Dimensions in mm









Dimensions in mm

• All specifications are subject to change without notice.